



APA750-BGG456 Information



For Reference Only

Part Number APA750-BGG456

Manufacturer Microsemi Corporation

Category Integrated Circuits (ICs)

Embedded - FPGAs (Field Programmable Gate

Array)

Description IC FPGA 356 I/O 456BGA

Package 456-BBGA

For the pricing/inventory/lead time, please contact

us

Website: https://www.heisener.com E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









APA750-BGG456 Specifications

Manufacturer Part Number	APA750-BGG456
Manufacturer	Microsemi Corporation
Category	Integrated Circuits (ICs)
	Embedded - FPGAs (Field Programmable Gate Array)
Package	456-BBGA
Series	ProASICPLUS
Number of LABs/CLBs	-
Number of Logic Elements/Cells	-
Total RAM Bits	147456
Number of I/O	356
Number of Gates	750000
Voltage - Supply	2.3 V ~ 2.7 V
Mounting Type	Surface Mount
Operating Temperature	$0^{\circ}\text{C} \sim 70^{\circ}\text{C} \text{ (TA)}$
Package / Case	456-BBGA
Supplier Device Package	456-PBGA (35x35)
	Report errors's

APA750-BGG456 Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

APA750-BGG456 Payment Methods



















APA750-BGG456 Shipping Methods













If you have any question about APA750-BGG456, please do not hesitate to contact us!

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